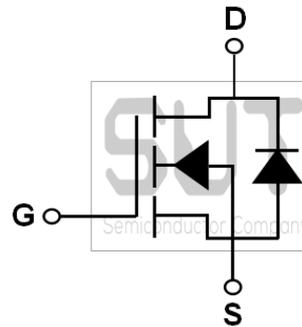
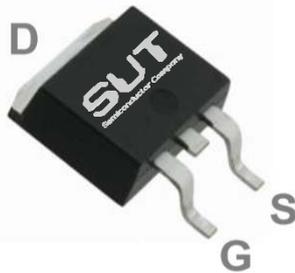


## N-Channel 30-V<sub>(D-S)</sub> MOSFET

PRODUCT SUMMARY		
B <sub>VDSS</sub> (V)	R <sub>DS(on)</sub> (mΩ)(MAX)	I <sub>D</sub> (A)
30	6.0@V <sub>GS</sub> =10V	60

### TO252 Pin Configuration



### ABSOLUTE MAXIMUM RATINGS(T<sub>C</sub>=25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V <sub>DS</sub>	30	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous (T <sub>C</sub> =25°C)	I <sub>D</sub>	60	A
Drain Current-Continuous (T <sub>C</sub> =100°C)		38	A
Drain Current-Pulsed <sup>1</sup>	I <sub>DM</sub>	240	A
Single Pulse Avalanche Energy <sup>2</sup>	EAS	88	mJ
Single Pulse Avalanche Current <sup>2</sup>	IAS	42	A
Power Dissipation (T <sub>C</sub> =25°C)	P <sub>D</sub>	45	W
Power Dissipation-Derate above 25°C		0.36	W/°C
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-55 to 150	°C

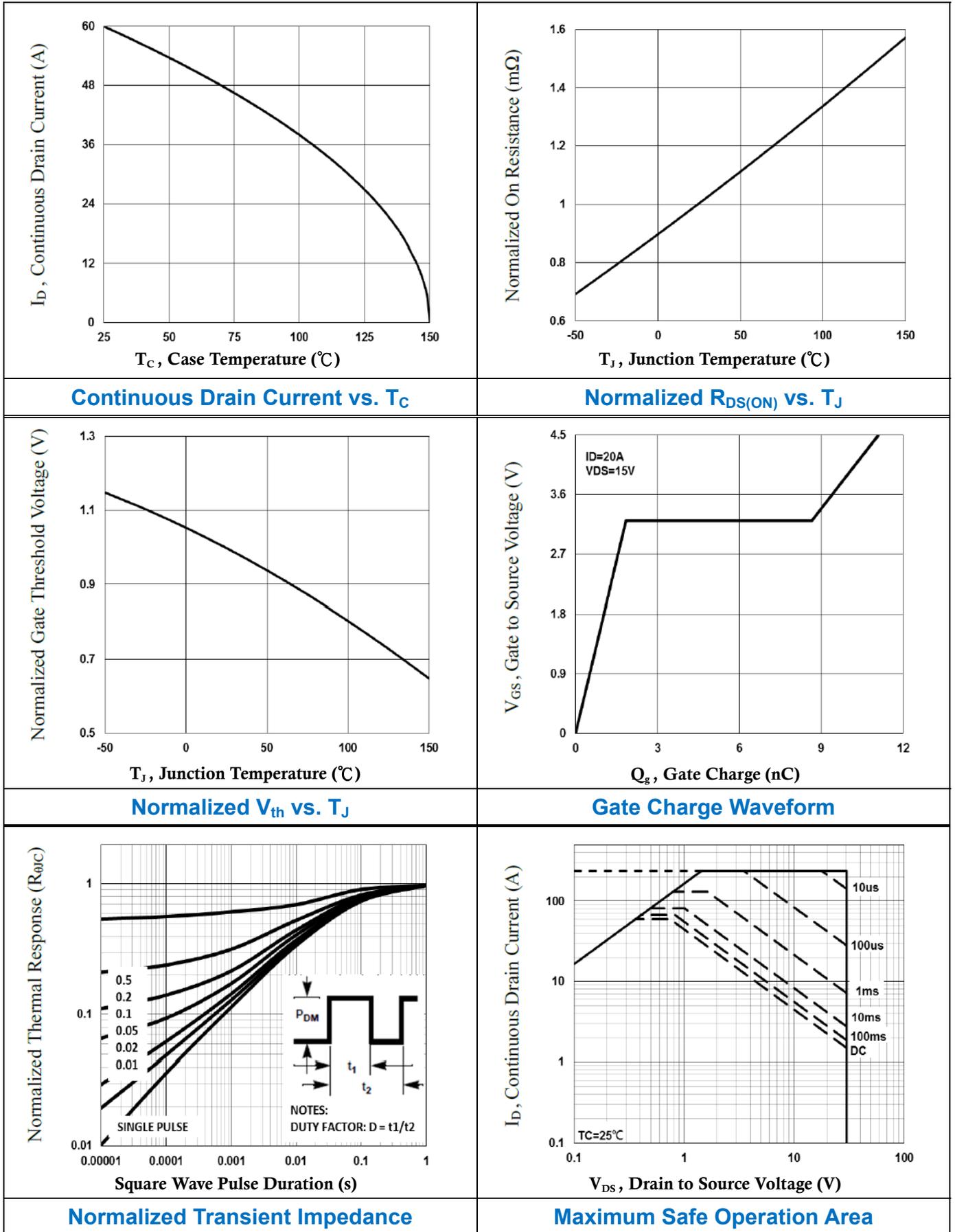
### THERMAL CHARACTERISTICS

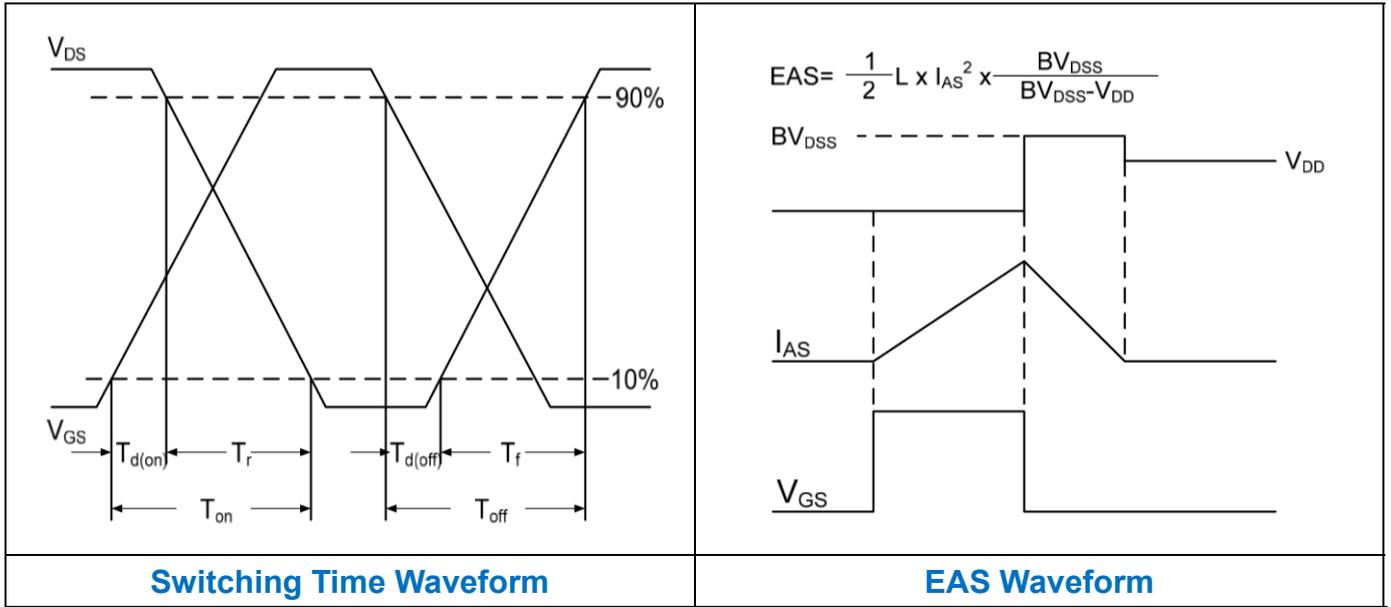
Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to ambient	R <sub>θJA</sub>	---	62	°C/W
Thermal Resistance Junction to Case	R <sub>θJC</sub>	---	2.8	°C/W

ELECTRICAL CHARACTERISTICS (T <sub>J</sub> =25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static State Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	30	---	---	V
BV <sub>DSS</sub> Temperature Coefficient	ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Reference to 25°C, I <sub>D</sub> =1mA	---	0.04	---	V/°C
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =30V, T <sub>J</sub> =25°C	---	---	1	μA
		V <sub>GS</sub> =0V, V <sub>DS</sub> =24V, T <sub>J</sub> =125°C	---	---	10	μA
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	---	---	±100	nA
Static Drain-Source On-Resistance <sup>3</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	---	4.8	6.0	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	---	6.7	9.0	mΩ
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250μA	1.2	1.6	2.5	V
V <sub>GS(th)</sub> Temperature Coefficient	ΔV <sub>GS(th)</sub>		---	-4.0	---	mV/°C
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =10A	---	23	---	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3, 4</sup>	Q <sub>g</sub>	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =15V, I <sub>D</sub> =20A	---	11.1	18	nC
Gate-Source Charge <sup>3, 4</sup>	Q <sub>gs</sub>		---	1.85	3.8	
Gate-Drain Charge <sup>3, 4</sup>	Q <sub>gd</sub>		---	6.8	12	
Turn-On Delay Time <sup>3, 4</sup>	T <sub>d(on)</sub>	V <sub>GS</sub> =10V, V <sub>DD</sub> =15V, R <sub>G</sub> =3.3Ω, I <sub>D</sub> =15A	---	7.5	14	ns
Rise Time <sup>3, 4</sup>	T <sub>r</sub>		---	14.5	28	
Turn-Off Delay Time <sup>3, 4</sup>	T <sub>d(off)</sub>		---	35.2	67	
Fall Time <sup>3, 4</sup>	T <sub>f</sub>		---	9.6	18	
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =25V, F=1MHz	---	1210	1800	pF
Output Capacitance	C <sub>oss</sub>		---	190	280	
Reverse Transfer Capacitance	C <sub>rss</sub>		---	100	150	
Gate resistance	R <sub>g</sub>	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, F=1MHz	---	2.5	5.0	Ω
<b>Guaranteed Avalanche Energy</b>						
Single Pulse Avalanche Energy	EAS	V <sub>DD</sub> =25V, L=0.1mH, I <sub>AS</sub> =20A	20	---	---	mJ
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	I <sub>S</sub>	V <sub>G</sub> =V <sub>D</sub> =0V, Force Current	---	---	60	A
Pulsed Source Current <sup>3</sup>	I <sub>SM</sub>		---	---	240	A
Diode Forward Voltage <sup>3</sup>	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =1A, T <sub>J</sub> =25°C	---	---	1.0	V
Reverse Recovery Time	t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =1A, di/dt=100A/μs, T <sub>J</sub> =25°C	---	---	---	ns
Reverse Recovery Charge	Q <sub>rr</sub>		---	---	---	nC

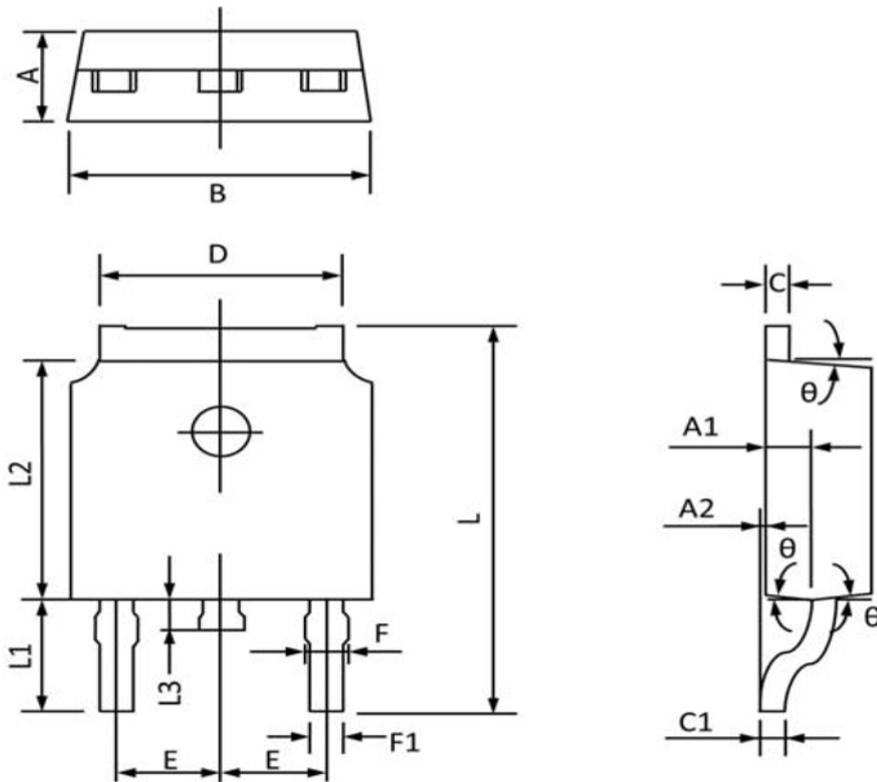
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V<sub>GS</sub>=10V, V<sub>DD</sub>=25V, L=0.1mH, I<sub>AS</sub>=42A, R<sub>G</sub>=25Ω, Starting T<sub>J</sub>=25°C.
3. The data tested by pulsed, pulse width ≤ 300μs, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.





TO252 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
A	2.400	2.200	0.094	0.087
A1	1.110	0.910	0.044	0.036
A2	0.150	0.000	0.006	0.000
B	6.800	6.400	0.268	0.252
C	0.580	0.450	0.023	0.018
C1	0.580	0.460	0.023	0.018
D	5.500	5.100	0.217	0.201
E	2.386	2.186	0.094	0.086
F	0.940	0.600	0.037	0.024
F1	0.860	0.500	0.034	0.020
L	10.400	9.400	0.409	0.370
L1	3.000	2.400	0.118	0.094
L2	6.200	5.400	0.244	0.213
L3	1.200	0.600	0.047	0.024
θ	9°	3°	9°	3°